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## (WO/1988/004592) PROCESS AND DEVICE FOR CUTTING MATERIALS WITH A LASER BEAM

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Title: PROCESS AND DEVICE FOR CUTTING MATERIALS WITH A LASER BEAM

Abstract: In order to avoid accidental injuries of the operator or damage to the material being cut by means of a laser beam, a process is disclosed by which a compact jet of a liquid transparent to laser radiation is generated immediately before the outlet of the laser radiation from a light guide and directed towards the material to be cut. A device for implementing this process is also disclosed.

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